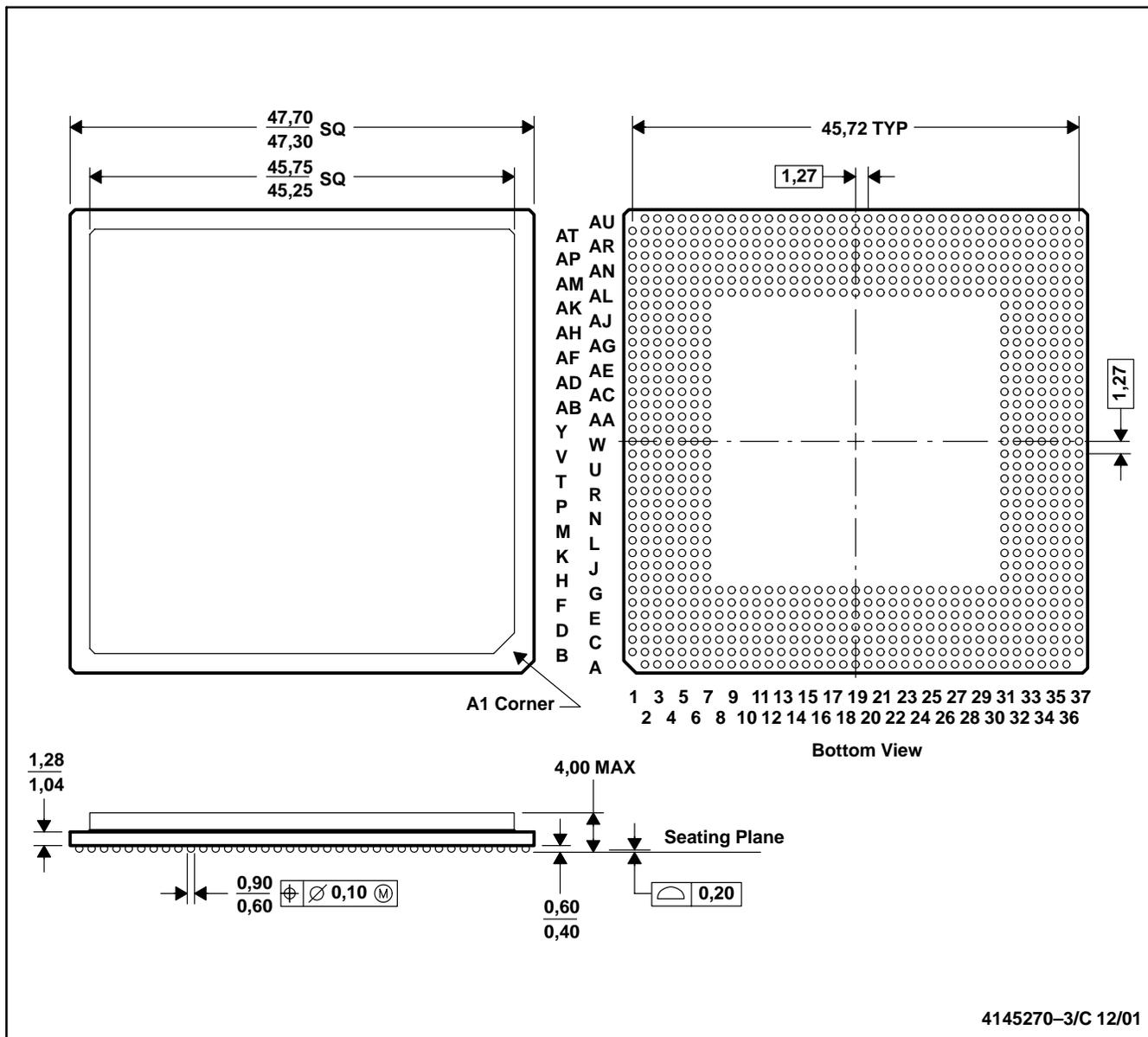


GHT (S-PBGA-N836)

PLASTIC BALL GRID ARRAY



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice
 C. Flip chip application only.

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265